

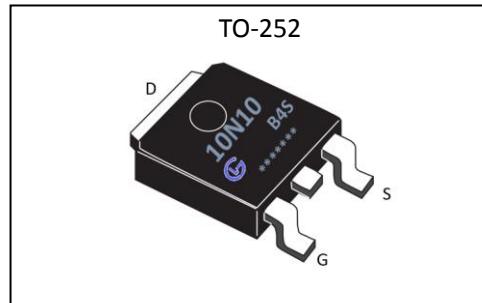
GL Silicon N-Channel Power MOSFET
General Description :

The GL10N10B4S uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications. The package form is TO-252, which accords with the RoHS standard.

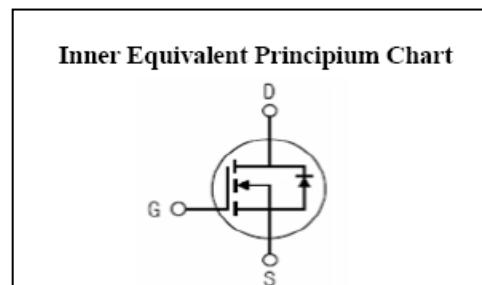
V_{DSS}	100	V
I_D	10	A
P_D	40	W
$R_{DS(ON)type}$	110	$m\Omega$

Features :

- $R_{DS(ON)} < 140m\Omega$ @ $V_{GS}=10V$ (Typ : 110m Ω)
- High density cell design for ultra low $R_{ds(on)}$
- Fully characterized avalanche voltage and current
- Excellent package for good heat dissipation


Applications :

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply


Absolute ($T_c = 25^\circ C$ unless otherwise specified) :

Symbol	Parameter	Rating	Units
V_{DSS}	Drain-to-Source Voltage	100	V
I_D	Continuous Drain Current	10	A
I_{DM}	Pulsed Drain Current	40	A
V_{GS}	Gate-to-Source Voltage	± 20	V
P_D	Power Dissipation	40	W
E_{AS}	Single pulse avalanche energy ^{a5}	20	mJ
T_J, T_{stg}	Operating Junction and Storage Temperature Range	175, -55 to 175	°C



GL10N10B4S

无锡光磊电子科技有限公司

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Electrical Characteristics ($T_c = 25^\circ\text{C}$ unless otherwise specified) :

OFF Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
V_{DSS}	Drain to Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu\text{A}$	100	--	--	V
I_{DSS}	Drain to Source Leakage Current	$V_{DS}=100\text{V}, V_{GS}=0\text{V}, T_a = 25^\circ\text{C}$	--	--	1.0	μA
$I_{GSS(F)}$	Gate to Source Forward Leakage	$V_{GS}=+20\text{V}$	--	--	0.1	μA
$I_{GSS(R)}$	Gate to Source Reverse Leakage	$V_{GS}=-20\text{V}$	--	--	-0.1	μA

ON Characteristics ^{a3}						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$R_{DS(ON)}$	Drain-to-Source On-Resistance	$V_{GS}=10\text{V}, I_D=10\text{A}$	--	110	140	$\text{m}\Omega$
$V_{GS(\text{TH})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	1	--	2.5	V

Pulse width $t_p \leq 380\mu\text{s}, \delta \leq 2\%$

Dynamic Characteristics ^{a4}						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
g_{fs}	Forward Transconductance	$V_{DS}=5\text{V}, I_D=5\text{A}$	--	7	--	S
C_{iss}	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=50\text{V}$	--	255	--	pF
C_{oss}	Output Capacitance	$f=1.0\text{MHz}$	--	14	--	
C_{rss}	Reverse Transfer Capacitance		--	3	--	

Resistive Switching Characteristics ^{a4}						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$t_{d(\text{ON})}$	Turn-on Delay Time	$V_{DD}=50\text{V}, R_L=10\Omega$	--	5	--	ns
t_r	Rise Time		--	3	--	
$t_{d(\text{OFF})}$	Turn-Off Delay Time		--	16	--	
t_f	Fall Time		--	4	--	
Q_g	Total Gate Charge	$V_{DD}=50\text{V}, I_D=3\text{A}$	--	4	--	nC
Q_{gs}	Gate to Source Charge		--	1.6	--	
Q_{gd}	Gate to Drain ("Miller")Charge		--	1	--	



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Source-Drain Diode Characteristics

Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
I _S	Continuous Source Current ^{a2} (Body Diode)		--	--	10	A
V _{SD}	Diode Forward Voltage ^{a3}	I _S =10A, V _{GS} =0V	--	--	1.2	V

Symbol	Parameter	Typ.	Units
R _{θJC}	Junction-to-Case ^{a2}	3.8	°C/W

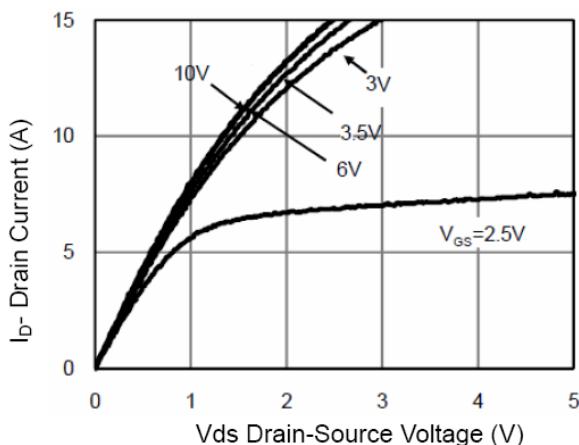
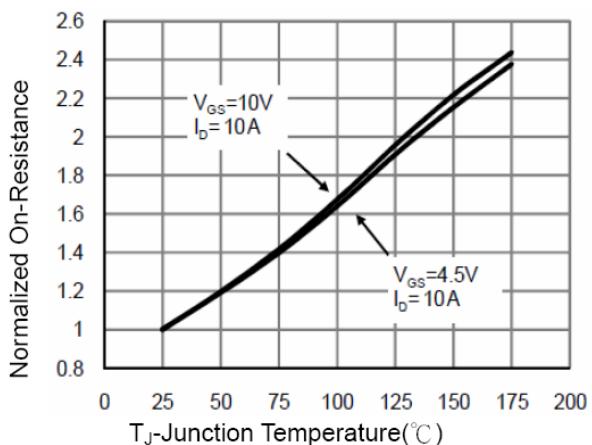
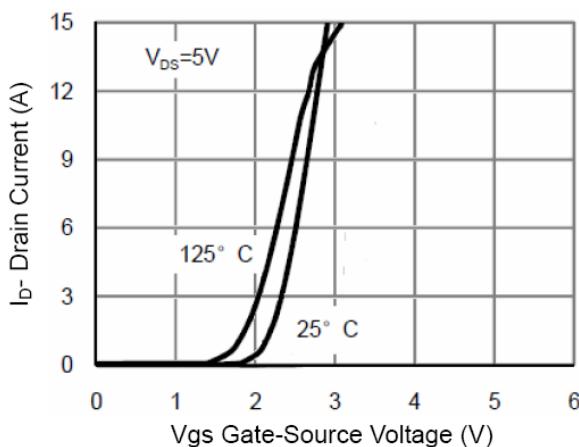
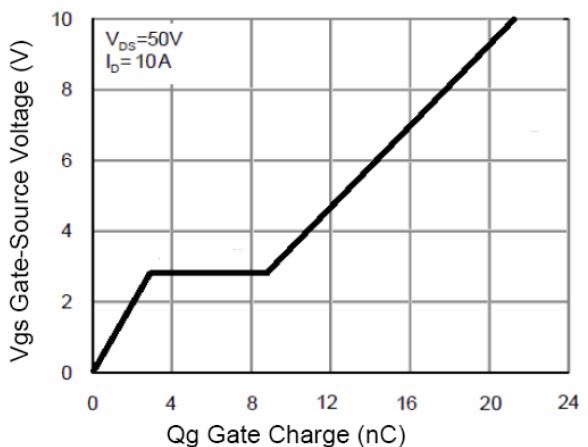
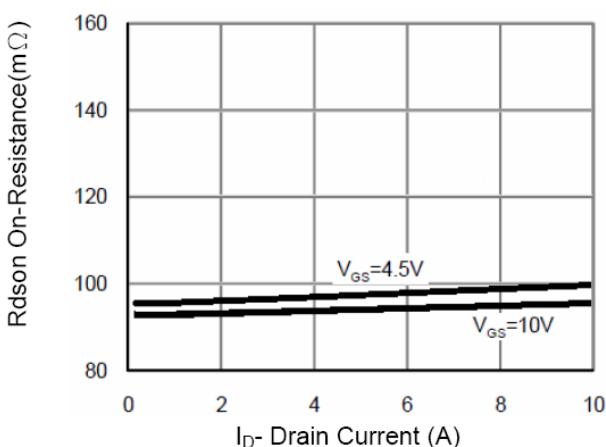
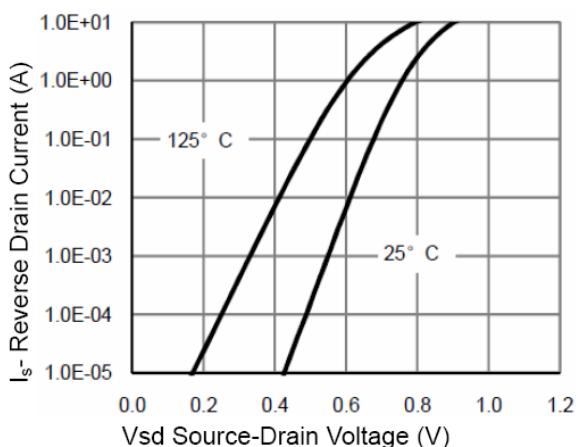
^{a1} : Repetitive Rating: Pulse width limited by maximum junction temperature.

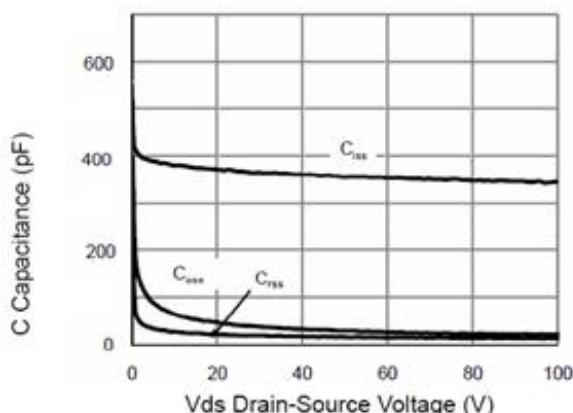
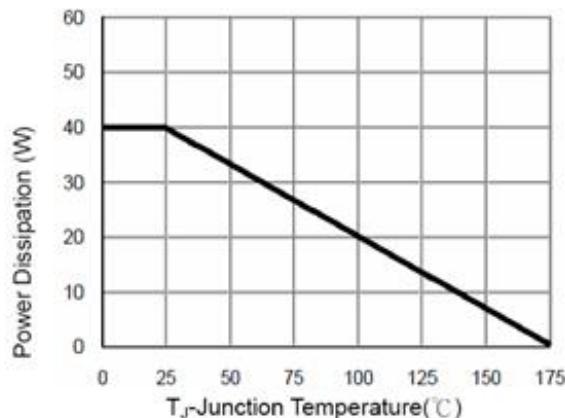
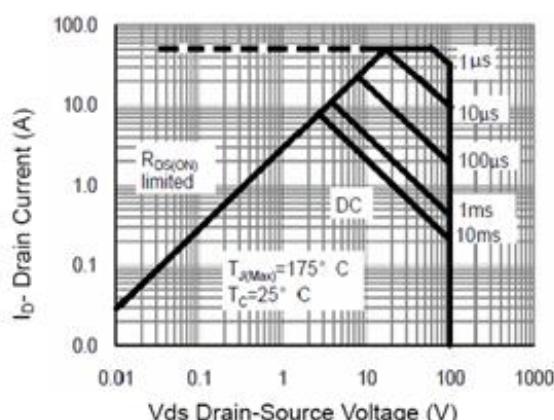
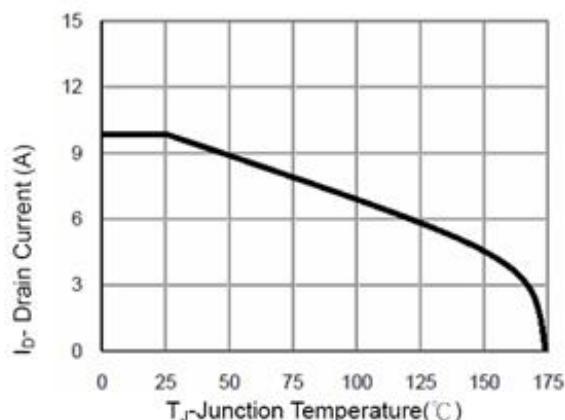
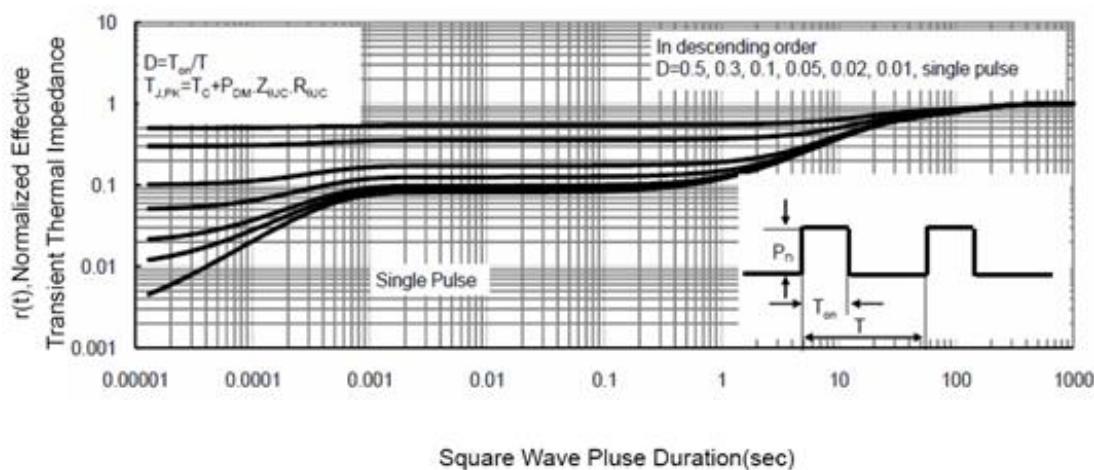
^{a2} : Surface Mounted on FR4 Board, t≤10sec.

^{a3} : Pulse Test: Pulse Width≤300μs, Duty Cycle≤2%.

^{a4} : Guaranteed by design, not subject to production

^{a5} : EAS condition : T_j=25°C, V_{DD}=50V, V_G=10V, L=0.5mH, R_g=25Ω

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Figure 1 Output Characteristics

Figure 4 Rdson-JunctionTemperature

Figure 2 Transfer Characteristics

Figure 5 Gate Charge

Figure 3 Rdson- Drain Current

Figure 6 Source- Drift Diode Forward

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Figure 7 Capacitance vs Vds

Figure 9 Power De-rating

Figure 8 Safe Operation Area

Figure 10 Current De-rating

Figure 11 Normalized Maximum Transient Thermal Impedance

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